

30V 80A N-Channel Enhancement Mode Power MOSFET

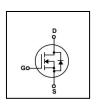
Features

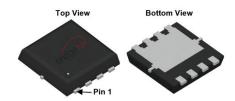
- RDSON \leq 4m Ω @Vgs=10V, Id=20A
- · Advanced trench technology
- Excellent RDS(ON) and Low Gate Charge
- · Lead free product is acquired

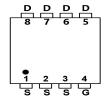
Application

- Load Switch
- PWM Application
- Power management

SYMBOL







PDFN5*6

ASSEMBLY MESSAGE

Product Name	Package	Packaging
BXT040N03C	PDFN5*6	Reel

ABSOLUTE MAXIMUM RATINGS (Tc=25°C unless otherwise noted)

Parameter		Symbol	Rating PDFN5*6	Unit
Drain-Source Voltage		V _{DSS}	30	V
Drain Current	Continuous (T _C = 25°C)		80	А
Drain Current	Continuous (T _C = 100°C)	l _D	51	А
Drain Current	Pulsed (Note1)		320	А
Single Pulsed Avalanche Energy		EAS	121	mJ
Gate-Source Voltage		V _{GSS}	±20	V
Power Dissipation	T _C =25°C	PD	44	W
Maximum Junction Temperature		TJ	150	°C
Storage Temperature Range		T _{STG}	-55 to 150	°C

Note: 1. Repetitive Rating: Pulse width limited by maximum junction temperature

THERMAL CHARACTERISTICS

Parameter	Symbol	Max.	Unit	
Parameter	Syllibol	PDFN5*6	Oill	
Thermal Resistance, Junction to Case	Rелс	2.84	°C / W	

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ELECTRICAL CHARACTERISTICS (T_J=25°C,unless otherwise Noted)

Parameter	Symbol	Test Condition	Min.	Тур.	Max.	Unit
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV _{DSS}	VGS=0V, ID=250µA	30			V
Zero Gate Voltage Drain Current	I _{DSS}	VDS=30V, VGS=0V			1	uA
Gate-Body Leakage Current, Forward		VGS=20V			100	nA
Gate-Body Leakage Current, Reverse	Igss	VGS=-20V			-100	nA
ON CHARACTERISTICS			•		•	
Gate Threshold Voltage	V _{GS(TH)}	VDS=VGS, ID=250μA	1.0	1.5	3.0	V
Drain-Source On-State Resistance	В	VGS=10V, ID=20A		2.9	4	mΩ
Dialii-Source Oii-State Resistance	$R_{DS(ON)}$	VGS=4.5V, ID=10A		4.2	6.5	mΩ
DYNAMIC PARAMETERS						
Input Capacitance	Ciss	VD9-15V VC9-0V		2612		pF
Output Capacitance	Coss	VDS=15V, VGS=0V, f=1.0MHz		396		pF
Reverse Transfer Capacitance	Crss			336		pF
SWITCHING PARAMETERS						
Turn-ON Delay Time	t _{D(ON)}			21		ns
Turn-ON Rise Time	t _R	VDD=15V, ID=30A, VGS =		29		ns
Turn-OFF Delay Time	t _{D(OFF)}	10V, RG=3Ω		70		ns
Turn-OFF Fall-Time	t _F			33		ns
Total Gate Charge(Note2)	Q_{G}	VDC 45V VCC 40V ID		30		nC
Gate Source Charge	Q _{GS}	VDS =15V, VGS =10V, ID		8		nC
Gate Drain Charge	Q _{GD}	=30A		10		nC
SOURCE- DRAIN DIODE RATINGS	AND CHAR	ACTERISTICS	•			
Drain-Source Diode Forward Voltage	V _{SD}	Is=30A, VGS=0V			1.4	V
Diode Continuous Forward Current	ls				80	Α
Maximum Pulsed Drain to Source Diode Forward Current	Ism				320	А
Body Diode Reverse Recovery Time	trr	. ,		25		ns
Body Diode Reverse Recovery Charge	Qrr	IF=20A, dI/dt=100A/μs		20		nC

Note: 2. Essentially independent of operating temperature



TYPICAL CHARACTERISTICS

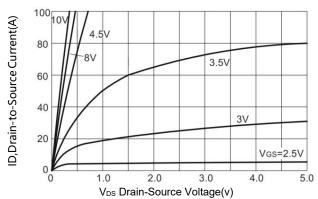


Figure 1. Typical Output Characteristics

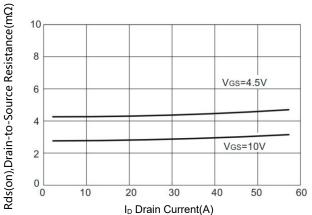


Figure 3. On-Resistance versus Drain Current

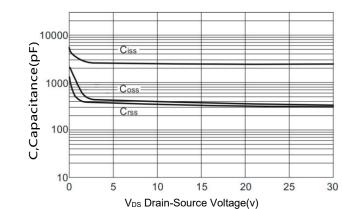


Figure 5. Typical Capacitance versus V_{DS}

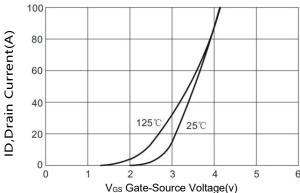


Figure 2. Typical Transfer Characteristics

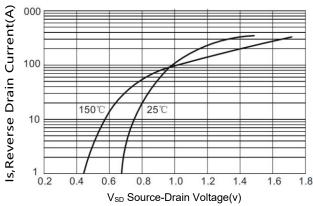


Figure 4. Diode forward voltage versus Current

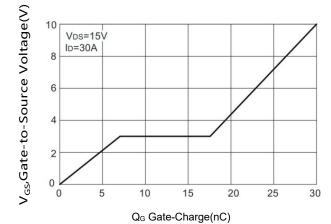


Figure 6. Typical Gate Charge versus V_{GS}



TYPICAL CHARACTERISTICS(Cont.)

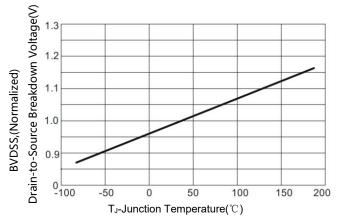


Figure 7. BV_{DSS} Variation with Temperature

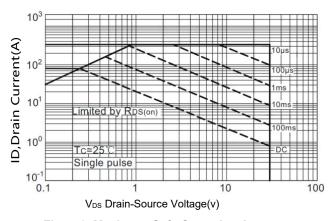


Figure 9. Maximum Safe Operating Area

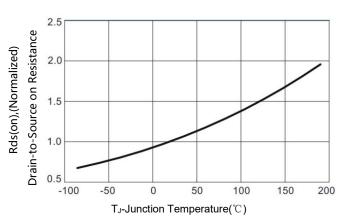


Figure 8. On-Resistance Variation with Temperature

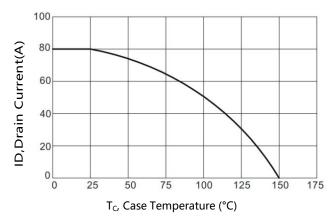
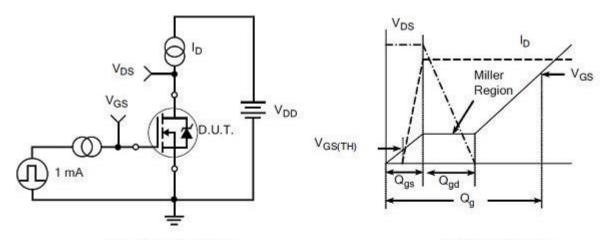


Figure 10. Maximum Continuous Drain Current versus Case Temperature

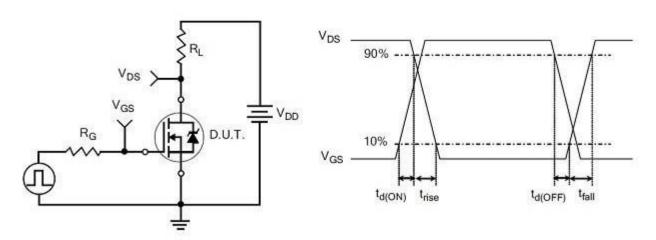


TEST CIRCUITS AND WAVEFORMS



Gate Charge Test Circuit

Gate Charge Waveform

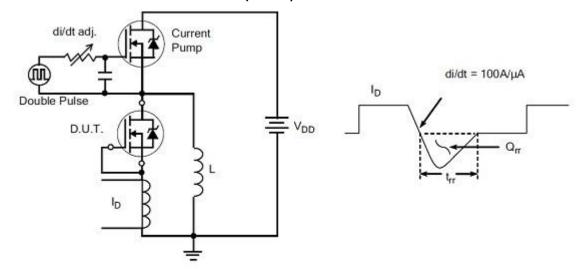


Resistive Switching Test Circuit

Resistive Switching Waveforms

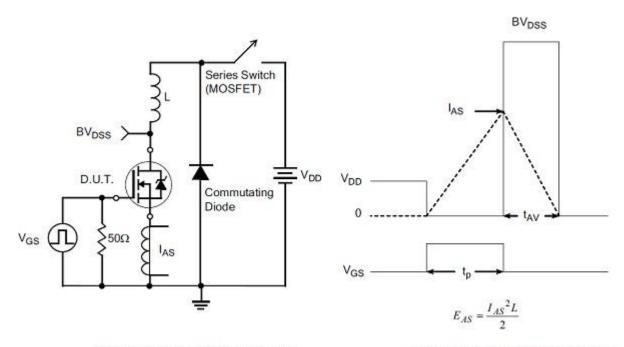


TEST CIRCUITS AND WAVEFORMS(Cont.)



Diode Reverse Recovery Test Circuit

Diode Reverse Recovery Waveform



Unclamped Inductive Switching Test Circuit

Unclamped Inductive Switching Waveforms



Revision history

Document revision history

Date	Revision	Changes
15-Nov-2021	1.0	First release

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